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38D2 群

应用于遥控器时的低功耗设计

1. 要点

本篇资料介绍当 38D2 群单片机应用于遥控器时的低功耗设计。

2. 说明

该应用说明适用于以下条件：

采用的 MCU：38D2 群（例如：M38D24G6HP）

振荡频率：X_{IN} 为 4MHz，X_{CIN} 为 32.768KHz

存储容量：ROM 24KB，RAM 640 字节

3. 内容

3.1 时钟的选择和切换

- 概要

对于单片机的低功耗设计来说，时钟的选择和切换是很重要的一点。当 38D2 群单片机应用于低功耗设计时，有以下几个设计要点：

1. 对于单片机的功能模块，尽量选择 X_{CIN} 作为时钟源。比如，定时器、LCD 显示模块等。如果 1 个 8 位定时器的定时时间不够长，可以选择 1 个 16 位定时器或者 2 个 8 位定时器串连的形式来满足长时间的定时需求。
2. 如果某些功能模块必须使用 X_{IN} 作为时钟源，可以在运行此功能模块之前，先使 X_{IN} 振荡起来，其功能运行完成后，再停掉 X_{IN} ，以此来降低系统的功耗。
3. 在大多数时间，尽量选择 X_{CIN} 作为系统时钟源。在必要时，再切换为 X_{IN} 工作。

- 实例说明

比如在进行有 LCD 显示的遥控器设计时，资源分配如下：

1. 定时器 X 用于 38KHz 载波输出，其时钟源为 X_{IN} ；
2. 定时器 3 用于载波输出的控制，其时钟源为 X_{IN} ；
3. 定时器 1 和定时器 2 串连用于 250ms 定时控制，其时钟源为 X_{CIN} ；
4. LCD 显示模块，其时钟源为 X_{CIN} ；
5. 系统工作时钟在平时没有按键和不需要发射载波信号时，选择 X_{CIN} 作为系统时钟源，停掉 X_{IN} ；在有按键唤醒后和需要发射载波信号之前，使 X_{IN} 振荡起来，等待稳定后切换到 X_{IN} 作为系统时钟源。

3.2 工作模式的切换

在没有按键时，在选择 X_{CIN} 作为系统时钟源的同时，设置系统进入 WIT 模式，从而降低系统功耗。因为 38D2 群的 LCD 驱动模块不能在 STP 模式下正常工作，为保证 LCD 在任何时刻都能正常显示，系统不能设置为 STP 模式，只能设置为 WIT 模式，达到降低功耗的效果。

针对实例，时钟的选择和切换以及工作模式的切换流程如下图：

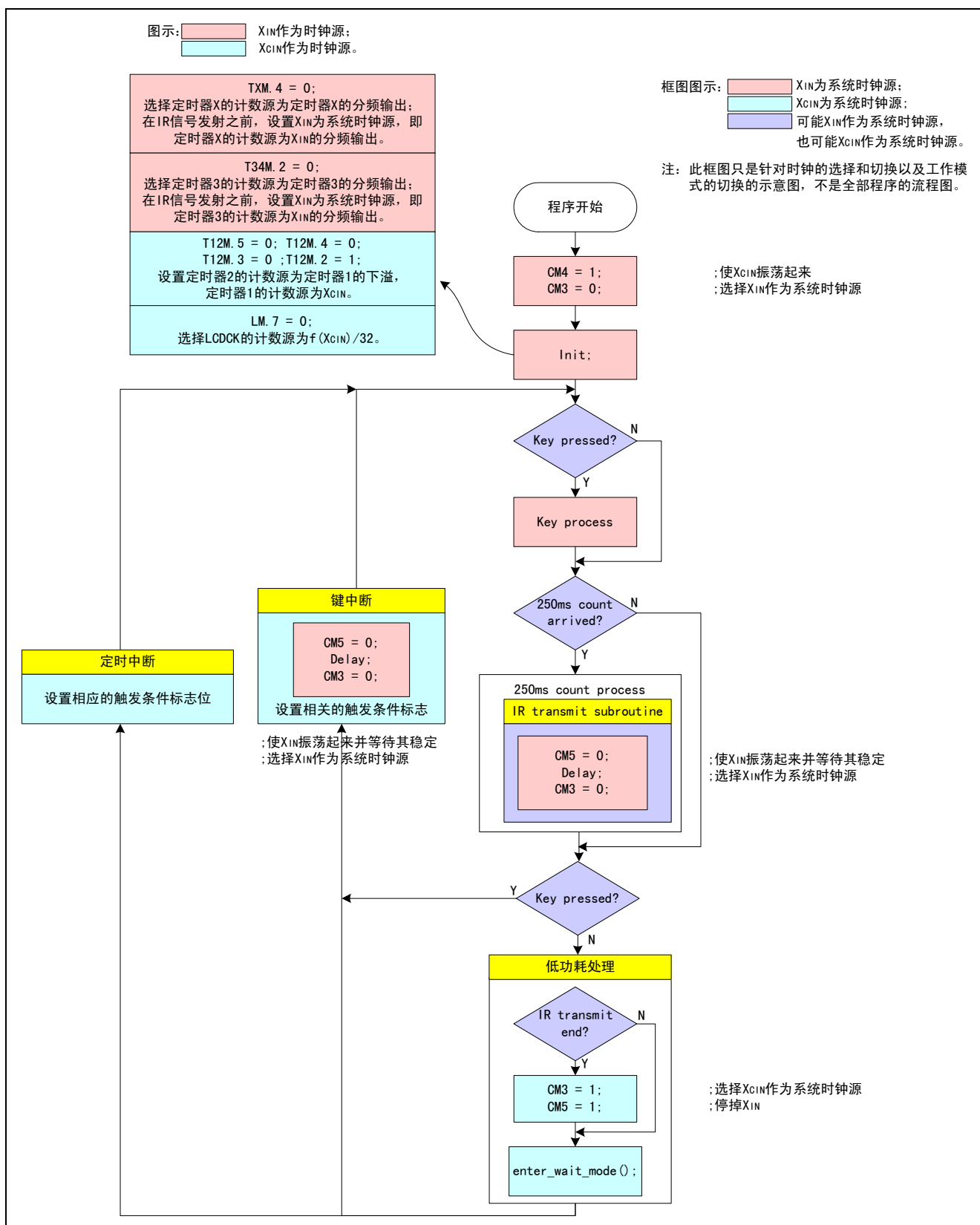


图 1. 时钟的选择和切换以及工作模式的切换

3.3 其他相关设置

3.3.1 LCD 分压电阻的选择

38D2 群的内部分压电阻阻值为 $200\text{K}\Omega$ 。在选择分压电阻阻值大于 $200\text{K}\Omega$ 的情况下，可以保证 LCD 显示清晰，可以设置外部分压电阻电路供给 LCD 驱动电路。因为分压电阻阻值越大，系统功耗就会越低。所以要在保证 LCD 显示清晰的情况下，尽量减小系统的功耗。

3.3.2 AD 电阻网络

在 38D2 群的 AD 转换电路中，AD 电阻网络与参考电压的输入管脚（VREF）可以通过 VREF 输入切换位（ADL 的 bit0 位）进行控制。当此位的值为“1”时，AD 电阻网络总是与 VREF 管脚相连。当此位的值为“0”时，AD 电阻网络在没有 AD 转换时不与 VREF 相连。当设计带有 AD 采样电路的遥控器时，设置此位的值为“0”，从而减小系统的功耗。

- 下图为一个使用 38D2 群设计的遥控器，其各项因素对减少功耗的作用的对比图：

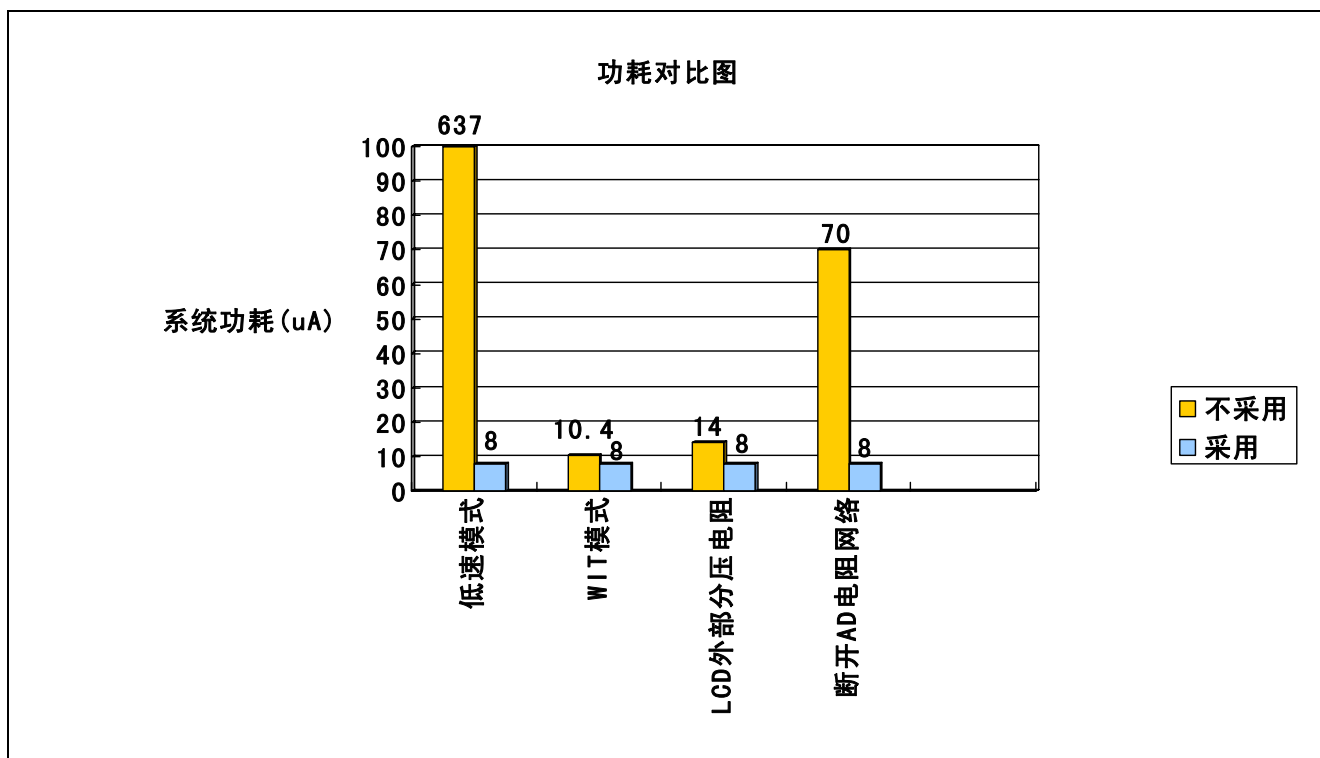


图 2.功耗对比图

【注】

1. XIN 作为系统时钟源时，系统时钟为 $XIN/2$ ，XCIN 作为系统时钟源时，系统时钟为 $XCIN/2$ 。
2. LCD 外部分压电阻为 $3\text{M}\Omega$ ，内部分压电阻为 $200\text{K}\Omega$ 。
3. 测试条件为 2.50V 工作电压。不同工作电压会影响系统功耗值。
4. 不同的系统电路会影响系统的功耗值。

4. 参考文献

硬件手册

38D2 群数据手册

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1.01	2008.03.17	5	更新咨询邮箱地址，修改硬件手册名称

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